# DELL OPTIPLEX 790

TECHNICAL GUIDEBOOK
INSIDE THE OPTIPLEX 790

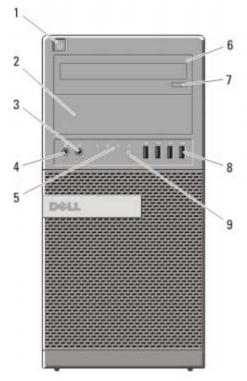


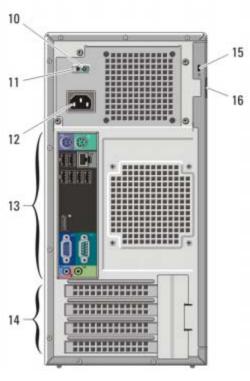
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# MINI TOWER COMPUTER (MT) VIEW

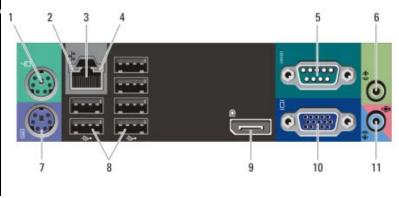




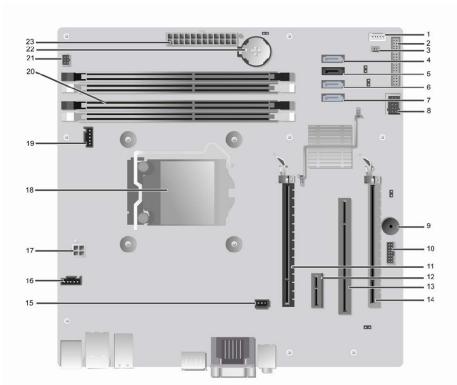
FR	ONT VIEW		
1	Power Button, Power Light	6	Optical Drive (optional)
2	Optical Drive Bay (optional)	7	Optical Drive Eject Button
3	Headphone Connector	8	USB 2.0 Connectors (4)
4	Microphone Connector	9	Drive Activity Light
5	Diagnostic Lights (4)		

BACK VIEW			
10	Power Supply Diagnostic Light	14	Expansion card slots(4)
11	Power Supply Diagnostic Button	15	Security cable slot
12	Power Connector	16	Padlock Ring
13	Back Panel Connectors		

BA	BACK PANEL CONNECTORS			
1	Mouse Connector	7	Keyboard Connector	
2	Link Integrity Light	8	USB Connectors (6)	
3	Network Connector	9	Display Port Connector	
4	Network Activity Light	10	VGA Connector	
5	Serial connector	11	Line-in/Microphone connector	
6	Line-out Connector			

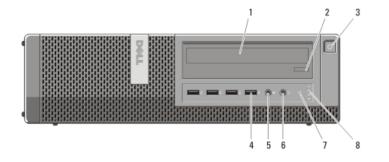


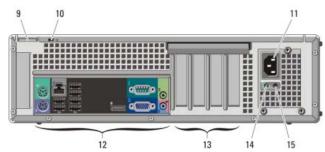
# MINI TOWER COMPUTER (MT) VIEW



Number	Name	Number	Name
1	Internal speaker connector(INT_SPKR)	13	PCI connector(SLOT3)
2	Front IO connector(FRONTPANEL)	14	PCI-e 4x connector(SLOT4)
3	Thermal sensor connector(THRM_2)	15	Intrusion switch connector(INTRUDER)
4	SATA 0 connector(SATA0)	16	System fan connector(FAN_HDD)
5	SATA 1 connector(SATA1)	17	P2 power connector(12V_PWRCONN)
6	SATA 2 connector(SATA2)	18	Processor connector(N/A)
7	SATA 3 connector(SATA3)	19	CPU fan connector(FAN_CPU)
8	Internal USB connector(INT_USB)	20	Memory connectors(DIMM1, DIMM2, DIMM3, DIMM4)
9	Buzzer(BEEP)	21	Power switch connector(PWR_SW)
10	LPC debug connector(LPC_DEBUG)	22	Battery connector(BATTERY)
11	PCI-e 16x connector(SLOT1)	23	P1 power connector(POWER)
12	PCI-e 1x connector(SLOT2)		

# DESKTOP COMPUTER (DT) VIEW

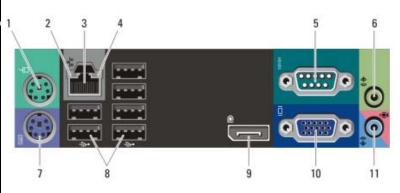




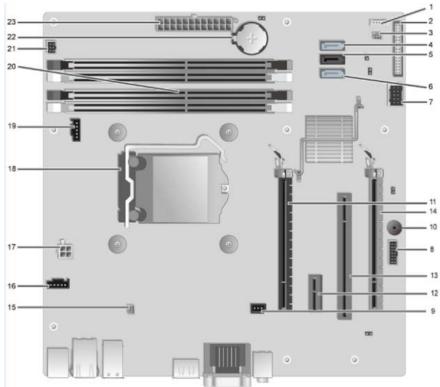
FRONT VIEW			
1	Optical Drive	5	Microphone Connector
2	Optical Drive Eject Button	6	Headphone Connector
3	Power Button, Power Light	7	Drive Activity Light
4	USB Connectors (4)	8	Diagnostic Lights (4)

ВА	CK VIEW		
9	Padlock Ring	13	Expansion card slots(4)
10	Security cable slot	14	Power Supply Diagnostic Light
11	Power Connector	15	Power Supply Diagnostic Button
12	Back Panel Connectors		

BA	BACK PANEL CONNECTORS			
1	Mouse Connector	7	Keyboard Connector	
2	Link Integrity Light	8	USB Connectors (6)	
3	Network Connector	9	Display Port Connector	
4	Network Activity Light	10	VGA Connector	
5	Serial connector	11	Line-in/Microphone connector	
6	Line-out Connector			

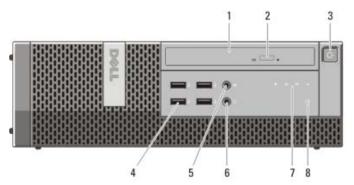


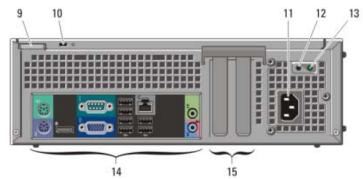
# DESKTOP COMPUTER (DT) VIEW



Number	Name	Number	Name
1	Internal speaker connector(INT_SPKR)	13	PCI connector(SLOT3)
2	Front IO connector(FRONTPANEL)	14	PCI-e 4x connector(SLOT4)
3	Thermal sensor connector(THRM_2)	15	Thermal sensor connector(THRM_1)
4	SATA 0 connector(SATA0)	16	System fan connector(FAN_HDD)
5	SATA 1 connector(SATA1)	17	P2 power connector(12V_PWRCONN)
6	SATA 2 connector(SATA2)	18	Processor connector(N/A)
7	Internal USB connector(INT_USB)	19	CPU fan connector(FAN_CPU)
8	LPC debug connector(LPC_DEBUG)	20	Memory connectors(DIMM1, DIMM2, DIMM3, DIMM4)
9	Intrusion switch connector (INTRUDER)	21	Power switch connector(PWR_SW)
10	Buzzer(BEEP)	22	Battery connector(BATTERY)
11	PCI-e 16x connector(SLOT1)	23	P1 power connector(POWER)
12	PCI-e 1x connector(SLOT2)		

# SMALL FORM FACTOR COMPUTER (SFF) VIEW

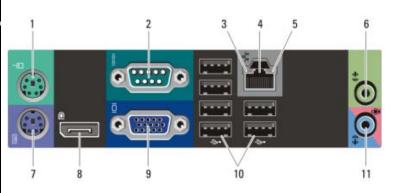




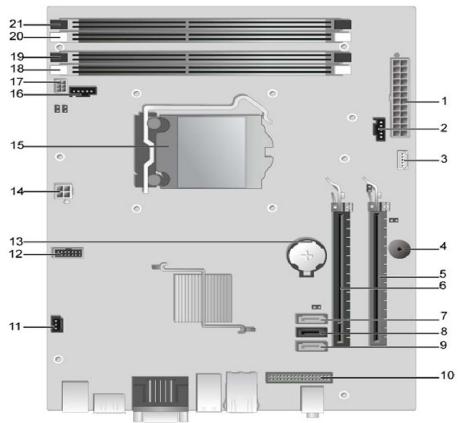
FRONT VIEW			
1	Optical Drive	5	Microphone Connector
2	Optical Drive Eject Button	6	Headphone Connector
3	Power Button, Power Light	7	Diagnostic Lights (4)
4	USB 2.0 Connectors (4)	8	Drive Activity Light

ВА	BACK VIEW		
9	Padlock Ring	13	Power Supply Diagnostic Light
10	Security cable slot	14	Back Panel Connectors
11	Power Connector	15	Expansion card slots(2)
12	Power Supply Diagnostic Button		

ВА	BACK PANEL CONNECTORS			
1	Mouse Connector	7	Keyboard Connector	
2	Serial connector	8	Display Port Connector	
3	Link Integrity Light	9	VGA Connector	
4	Network Connector	10	USB Connectors (6)	
5	Network Activity Light	11	Line-in/Microphone connector	
6	Line-out Connector			

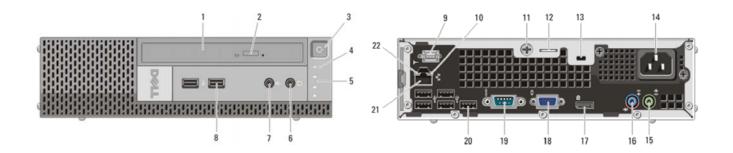


# SMALL FORM FACTOR COMPUTER (SFF) VIEW



Number	Name	Number	Name
1	P1 power connector(POWER)	12	LPC debug connector(LPC_DEBUG)
2	System fan connector(FAN_HDD)	13	Battery connector(BATTERY)
3	Internal speaker connector(INT_SPKR)	14	P2 power connector(12V_PWRCONN)
4	Buzzer(BEEP)	15	Processor connector(N/A)
5	PCI-e 4x connector(SLOT2)	16	CPU fan connector(FAN_CPU)
6	PCI-e 16x connector(SLOT1)	17	Power switch connector(PWR_SW)
7	SATA 2 connector(SATA2)	18	Memory connector(DIMM3)
8	SATA 1 connector(SATA1)	19	Memory connector(DIMM1)
9	SATA 0 connector(SATA0)	20	Memory connector(DIMM4)
10	Front IO connector(FRONTPANEL)	21	Memory connector(DIMM2)
11	Intrusion switch connector(INTRUDER)		

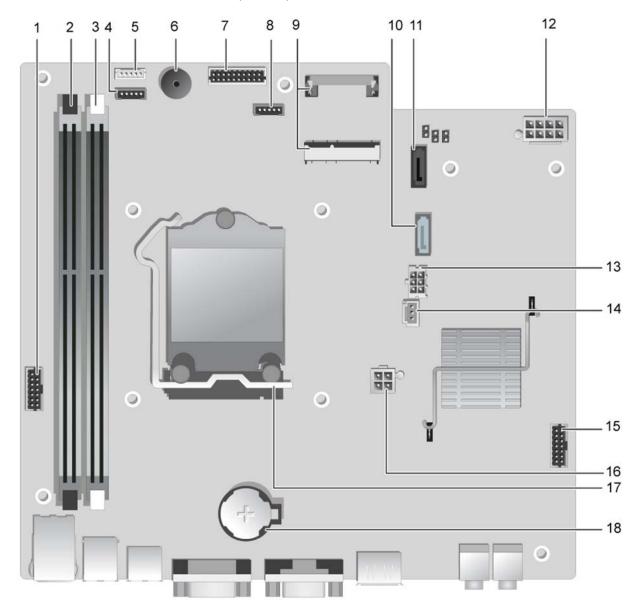
# ULTRA SMALL FORM FACTOR COMPUTER (USFF) VIEW



FR	ONT VIEW		
1	Optical Drive	5	Diagnostic Lights (4)
2	Optical Drive Eject Button	6	Headphone Connector
3	Power Button, Power Light	7	Microphone Connector
4	Drive Activity Light	8	USB Connectors (2)

	ВА	CK VIEW		
	9	Wi-Fi Antenna (optional)	16	Line-in/ Microphone Connector
1	10	Network Activity Light	17	Display Port Connector
1	11	Captive Thumbscrew	18	VGA Connector
	12	Padlock Ring	19	Serial Connector
	13	Security Cable Slot	20	USB Connectors (5)
	14	Power Connector	21	Network Connector
	15	Line-Out Connector	22	Link Integrity Light

# SMALL FORM FACTOR COMPUTER (USFF) VIEW



Number	Name	Number	Name
1	Front panel connector(FRONTPANEL)	10	SATA 1 connector(SATA_1)
2	Memory connector(DIMM_2)	11	SATA 0 connector(SATA_0)
3	Memory connector(DIMM_1)	12	P1 power connector(POWER1)
4	CPU fan connector(FAN_CPU)	13	HDD-ODD power connector (HDD_ODD_POWER)
5	Internal speaker connector(INT_SPKR)	14	Intrusion switch connector(INTRUDER)
6	Buzzer(BEEP)	15	LPC debug connector(LPC_DEBUG)
7	Front IO connector(F_USB_AUDIO)	16	P2 power connector(12V_PWRCONN)
8	System fan connector(FAN_HDD)	17	Processor connector(N/A)
9	Mini-PCI socket(PCIE_MINICARD)	18	Battery connector(BATTERY)

# MARKETING SYSTEM CONFIGURATIONS

NOTE: Offerings may vary by country. For more information regarding the configuration of your computer, click Start>Help and Support and select the option to view information about your computer.

## OPERATING SYSTEM

	МТ	DT	SFF	USFF	
Windows 7® operating system	Microsoft® Windows 7® Home Basic (32 and 64 bit) (select countries) Microsoft® Windows 7® Home Basic SP1 (32 and 64 bit) (select countries), Microsoft® Windows 7® Home Premium (32 and 64 bit), Microsoft® Windows 7® Professional (32 and 64 bit), Microsoft® Windows 7® Ultimate (32 and 64 bit), Microsoft® Windows 7 Starter SP1(32 bits), Microsoft® Windows 7 Starter SP1 w/MUI (32 bits)				
Windows Vista® operating system	Windows Vista® Home Basic SP2 (32 bits), Windows Vista® Business SP2 (32 and 64 bit), Windows Vista® Ultimate SP2 (32 bit)				
Windows XP® operating system	Basic Driver supp	oort only via Dell.co	om		
Other	FreeDOS for (N-series), Ubuntu® Linux version 10.10 (China only)				
OS Media Support Optional					

## CHIPSET

	MT	DT	SFF	USFF		
Chipset	Intel Q65 Express Chipset					
Non-volatile memory on chipset						
BIOS Configuration SPI (Serial Peripheral Interface)	64Mbit (8MB) and 16Mbit(2MB)located at SPI_FLASH on chipset					
TPM 1.2 Security Device (Trusted Platform Module) <sup>1</sup>	18KB located at TPM1.2 on chipset					
Non-TPM	Available in select countries					
NIC EEPROM	LOM configuration contained within SPI_FLASH – no dedicated LOM EEPROM					

#### **PROCESSOR**

NOTE: Global Standard Products (GSP) are a subset of Dell's relationship products that are managed for availability and synchronized transitions on a worldwide basis. They ensure the same platform is available for purchase globally. This allows customers to reduce the number of configurations managed on a worldwide basis, thereby reducing their costs. They also enable companies to implement global IT standards by locking in specific product configurations worldwide. The following GSP processors identified below will be made available to Dell customers.

NOTE: Processor numbers are not a measure of performance. Processor availability subject to change and may vary by region/country.

•				
	MT	DT	SFF	USFF
Intel® Quad Core Processors				
Intel® Core™ i7 2600 / 3.40GHz, 8M, VT-x, VT-d, TXT (vPro™), 95W	X-GSP	X-GSP	X-GSP	
Intel® Core™ i7 2600S / 2.80GHz, 8M, VT-x, VT-d, TXT (vPro™), 65W				X-GSP
Intel® Core™ i5 2500 / 3.30GHz, 6M, VT-x, VT-d, TXT (vPro™), 95W	X-GSP	X-GSP	X-GSP	
Intel® Core™ i5 2500S / 2.70GHz, 6M, VT-x, VT-d, TXT (vPro™), 65W				X-GSP
Intel® Core™ i5 2400 / 3.10GHz, 6M, VT-x, VT-d, TXT (vPro™), 95W	X-GSP	X-GSP	X-GSP	
Intel® Core™ i5 2400S / 2.50GHz, 6M, VT-x, VT-d, TXT (vPro™), 65W				X-GSP
Intel® Dual Core Processors				
Intel® Core™ i3 2120 / 3.30GHz, 3M, VT-x, 65W	Х	х	Х	х
Intel® Core™ i3 2100 / 3.10GHz, 3M, VT-x, 65W	Х	Х	Х	Х
Intel® Core™ i3 2130 / 3.40GHz, 3M, VT-x, 65W (after Oct 2011)	Х	Х	Х	Х
Intel® Pentium Processors				
IPP G850 SANDY BRIDGE Q-0 3MB 2c FCLGA 2.9GHz 65W HD GRAPHICS 2000 QS	Х	х	Х	х
IPP G840 SANDY BRIDGE Q-0 3MB 2c FCLGA 2.8GHZ 65W HD GRAPHICS 2000 QS	Х	Х	Х	Х
IPP G630 SANDY BRIDGE Q-0 3MB 2c FCLGA 2.7GHZ 65W HD GRAPHICS 2000 QS (after Oct 2011)	Х	Х	Х	х
IPP G620 SANDY BRIDGE Q-0 3MB 2c FCLGA 2.6GHZ 65W HD GRAPHICS 2000 QS	Х	х	Х	х
Intel® Celeron Processors (After October 2011)				
ICPG530 SANDY BRIDGE Q-02MB 2c FCLGA 2.4GHZ 65W HD GRAPHICS QS	х	х	х	х
IPP G440 SANDY BRIDGE Q-0 2MB 1.6GHZ 35W FCLGA11AQC	Х	Х	х	х
	•	•	•	•

#### **MEMORY**

NOTE: Memory modules should be installed in pairs of matched memory size, speed, and technology. If the memory modules are not installed in matched pairs, the computer will continue to operate, but with a slight reduction in performance. The entire 16-GB memory range is available to 64-bit operating systems.

	MT	DT	SFF	USFF	
Type: DDR3 Synch DRAM Non-ECC Memory		133	3MHz		
DIMM Slots	4	4	4	2	
DIMM Capacities	Up to 4GB	Up to 4GB	Up to 4GB	Up to 4GB	
Minimum Memory	1GB	1GB	1GB	1GB	
Maximum System Memory	16GB <sup>1</sup>	16GB <sup>1</sup>	16GB <sup>1</sup>	8GB <sup>1</sup>	
Memory configurations					
16GB <sup>1</sup> DDR3, 1333MHz, (4 DIMM)	×	Х	Х		
8GB <sup>1</sup> DDR3, 1333MHz, (2 DIMM)	Х	Х	Х	Х	
4GB <sup>1</sup> DDR3, 1333MHz, (2 DIMM)	Х	Х	Х	Х	
4GB <sup>1</sup> DDR3, 1333MHz, (1 DIMM)				Х	
3GB DDR3, 1333MHz, (2 DIMM)	Х	Х	Х	Х	
2GB DDR3, 1333MHz, (1 DIMM)	Х	Х	Х	Х	
1GB DDR3, 1333MHz, (1 DIMM)	Х	Х	Х	Х	

<sup>13</sup> 

# DRIVES AND REMOVABLE STORAGE

	MT	DT	SFF	USFF
Bays:				
5.25-inch bay (External Optical)	2	1	1 (slim-line)	1 (slim-line)
Hard Drives Supported (Internal and External)	2	1	1	1
Optical Drives Supported	2	1	1	1
Interface:				
SATA 2.0	3	2	2	1
SATA 3.0	1	1	1	1
3.5" Hard Drives:				
1TB <sup>1</sup> SATA 7200 RPM HDD	Х	Х	Х	
500GB <sup>1</sup> SATA 7200 RPM HDD	Х	Х	Х	
320GB <sup>1</sup> SATA 7200 RPM HDD	Х	Х	Х	
250GB <sup>1</sup> SATA 7200 RPM HDD	Х	Х	Х	
2.5" Hard Drives:				
500GB <sup>1</sup> SATA 7200 RPM HDD	Х	Х	Х	Х
500GB <sup>1</sup> SATA 7200 RPM Hybrid HDD	Х	Х	Х	Х
320GB <sup>1</sup> with and without FIPS Full DISK EnCRYPTION SATA HDD (available after May19, 2011)	Х	Х	Х	Х
250GB <sup>1</sup> SATA 7200 RPM HDD	Х	Х	Х	Х
128GB <sup>1</sup> SATA Solid State Drive HDD	Х	Х	Х	Х

#### DRIVES AND REMOVABLE STORAGE

	MT	DT	SFF	USFF		
Optical Drive: (SFF/USFF require slim-line optical drive)						
DVD+/-RW <sup>2</sup>	SATA 1.5Gbit/s	SATA 1.5Gbit/s	SATA 1.5Gbit/s	SATA 1.5Gbit/s		
DVD-ROM <sup>3</sup>	SATA 1.5Gbit/s	SATA 1.5Gbit/s	SATA 1.5Gbit/s	SATA 1.5Gbit/s		
Media Card Reader:						
Dell 19 in 1 Media Card Reader	Х	Х				

NOTE: Dell 19 in 1 Media Card Reader is supported via a F5 to F3 bracket on the MT and DT

#### SYSTEM EXPANSION SLOTS

NOTE: See Detailed Engineering Specifications for supported voltage, maximum wattage and card dimensions.

NOTE: Add in card location and priority: PCI: 1394; PCIe x16: GFX, USB 3.0, Serial, Parallel/Serial, NIC, Wireless; PCIe x4: GFX, USB 3.0, Serial, Parallel/Serial, NIC, Wireless; PCIe x1: USB 3.0, Serial, Parallel/Serial, NIC, Wireless

	MT	DT	SFF	USFF
PCI Slot(s): number of	1	1		
PCle x16 Slot: number of	1	1	1	
PCIe x16 (wired x4)Slot: number of	1	1	1	
PCIe x1 Slot: number of	1	1		
miniPCle connector: number of				1
Serial ATA (SATA)	4	3	3	2

<sup>&</sup>lt;sup>1</sup> For hard drives, GB means 1 billion bytes; actual capacity varies with preloaded material and operating environment and will be less.

<sup>&</sup>lt;sup>2</sup> Discs burned with this drive may not be compatible with some existing drives and players; using DVD+R media provides maximum compatibility.

<sup>&</sup>lt;sup>3</sup> DVD-ROM drives may have write-capable hardware that has been disabled via firmware modifications.

## GRAPHICS/VIDEO CONTROLLER

NOTE: MT supports full height card, DT supports low profile card. SFF supports low profile card.

	MT	DT	SFF	USFF
Intel HD Graphics [with Celeron/Pentium class CPU-GPU combo] Intel HD Graphics 2000[with iCore Dual/Quad core class CPU-GPU combo]		Integrated	d on CPU	
Enhanced Graphic/Video Options				
1GB AMD RADEON HD 6450 with DP and DVI		Optional card		
512MB AMD RADEON HD 6350 with dual DVI or dual VGA (adapters convert to dual DVI or dual VGA)		Optional card		

## EXTERNAL PORTS/CONNECTORS

NOTE: MT supports full height card, DT supports low profile card. SFF supports low profile card.

See chassis diagrams section for port/connector locations	MT	DT	SFF	USFF	
USB 2.0 (1 internal on MT and DT)		4 Front, 6 Rear			
Serial	1 Rear				
Parallel/2nd Serial via optional PClex1 card	Optional FH card				
2nd Parallel via optional PClex1 card (after August 2011)		Optional LP card			
Network Connector (RJ-45)					
PS/2	2 Rear				
1394 Controller via optional PCI card	Optional FH card	Optional LP card			
USB 3.0 via optional PClex1 card	Optional FH card	Optiona	I LP card		
Video:					
VGA		1 R	ear		
DisplayPort	1 Rear				
Audio:					
Line in for microphone	1 Front				
Line in for microphone or stereo	1 Rear				
Line out for headphones or speakers		1 Front	, 1 Rear		

# COMMUNICATIONS - NETWORK ADAPTER (NIC)

NOTE: MT supports full height card, DT supports low profile card. SFF supports low profile card.

	MT	DT	SFF	USFF
Intel® 82579LM Gigabit <sup>1</sup> Ethernet LAN 10/100/1000 (Remote Wake Up, PXE support and Intel Active Management Technology support)	Integrated on system board			
Broadcom NetXtreme 10/100/1000 PCIe Gigabit Networking Card	Op			

<sup>&</sup>lt;sup>1</sup> This term does not connote an actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

## COMMUNICATIONS - WIRELESS

	MT	DT	SFF	USFF
Dell Wireless 1520 PCIe WLAN card (802.11n)	Optional via add-in card			
Dell Wireless 1520 half miniPCIe WLAN card (802.11n)				Optional

# AUDIO AND SPEAKERS

	MT	DT	SFF	USFF	
Realtek ALC269Q High Definition Audio Codec	Integrated on system board				
Internal Dell Business Audio Speaker	Optional				
Dell AX210 2.0 Desktop Speakers	Optional				
Dell AX510/AX510PA Flat Panel Soundbar Speakers	Optional				

## KEYBOARD AND MOUSE

	MT	DT	SFF	USFF	
Dell USB Entry Keyboard with optional palmrest	Standard				
Dell Multimedia Pro Keyboard	Optional				
Dell Smartcard Keyboard	Optional				
Dell USB Optical Mouse	Standard				
Dell Laser Mouse	Optional				

#### **SECURITY**

	MT	DT	SFF	USFF		
Trusted Platform Module (TPM) 1.2 <sup>1</sup>	Integrated on system board					
Chassis Intrusion Switch	Optional					
Dell Smartcard Keyboard	Optional					
Chassis lock slot and loop support	Standard					
Dell Data Protection   Hardware Encryption Engine	Optional. Available in Q3 2011					

<sup>&</sup>lt;sup>1</sup>TPM is not available in all countries. Depending on your country regulations, No-TPM system boards will be made available.

#### SOFTWARE

	MT	DT	SFF	USFF	
Dell Client Manager	Available via Dell.com				
Dell Data Protection/Access (DDPA)	Standard				
Norton 2010 Internet Security	30 Day Trial or Optional Subscription				
McAfee 10 SecurityCenter	30 Day Trial or Optional Subscription				
Dell Data Protection   Encryption (DDPE)	Optional. Available in Q3 2011				

#### **ENVIRONMENTAL**

NOTE: For more details on Dell Environmental features, please to go to Environmental Attributes section. See your specific region for availability.

	MT	DT	SFF	USFF
Sustainable packaging	X	Х	Х	
BFR/PVC—free limited configurations				
MultiPack packaging	Optional, US only			
Energy Efficient Power Supply	Optional			Standard

#### **ALL-IN-ONE STANDS AND MOUNTS**

	MT	DT	SFF	USFF
Small Form Factor AIO Stand			Optional	
Ultra Small Form Factor AIO Stand				Optional
Ultra Small Form Factor Wall Mount / Desk Mount				Optional

#### SERVICE AND SUPPORT

NOTE: For more details on Dell Service Plans please to go to: www.dell.com/service/service\_plans

	MT	DT	SFF	USFF
3 Year Warranty <sup>1</sup> Next Business Day On-site <sup>2</sup> (3-3-3)	Standard			
ProSupport	Optional			

<sup>&</sup>lt;sup>1</sup> For a copy of our guarantees or limited warranties, please write Dell USA L.P., Attn: Warranties, One Dell Way, Round Rock, TX 78682. For more

information, visit www.dell.com/warranty. <sup>2</sup> Service may be provided by third-party. Technician will be dispatched if necessary following phone-based troubleshooting. Subject to parts availability, geographical restrictions and terms of service contract. Service timing dependent upon time of day call placed to Dell. U.S. only.

# DETAILED ENGINEERING SPECIFICATIONS

SYSTEM DIMENSIONS (PHYSICAL)

NOTE: System Weight and Shipping Weight is based on a typical configuration and may vary based on PC configuration. A typical configuration includes: integrated graphics, one hard drive, one optical drive, and one diskette drive.

	MT	DT	SFF	USFF	
Chassis Volume (liters)	26.27	15.06	8.38	3.70	
Chassis Weight (pounds/kilograms)	19.55 / 8.87	16.67 / 7.56	12.57 / 5.70	7.20 / 3.27	
Chassis Dimensions: (HxWxD)					
Height (inches/centimeters)	14.17 / 36	14.17 / 36	11.42 / 29	9.32 / 23.67	
Width (inches/centimeters)	6.89 / 17.5	4.02 / 10.2	3.65 / 9.26	2.56 / 6.5	
Depth (inches/centimeters)	16.42 / 41.7	16.14 / 41	12.28/31.2	9.44 / 24	
Shipping Weight (pounds/kilograms - includes packaging materials)	23.45 / 10.64	20.03 / 9.09	15.2 / 6.89	9.56/ 4.34	
Packaging Parameters (HxWxD)					
Height (inches/centimeters)	21.31/54.13	21.31 / 54.13	19.25/48.90	19.13/48.59	
Width (inches/centimeters)	18.75/47.63	18.75/47.63	15.81/40.16	14.38/36.53	
Depth (inches/centimeters)	14.09 / 35.79	10.84/27.53	10.19/25.88	9.63/24.46	

## SYSTEM EXPANSION SLOTS

	MT	DT	SFF	USFF
PCI Slot (Voltage supported 3.3V/5V/12V/-12V)	1	1		
Height (inches/centimeters)	4.376 / 11.115	2.731 /6.89		
Length (inches/centimeters)	6.6 / 16.765	6.6/16.765		
Maximum Wattage	25W	25W		
PClex16 Slot (BLUE) (Voltage supported 3.3V/12V)	1	1	1	
Height (inches/centimeters)	4.376 / 11.115	2.731 /6.89	2.731 /6.89	
Length (inches/centimeters)	6.6/ 16.765	6.6 /16.765	6.6 /16.765	
Maximum Wattage	35W	35W	35W	
PClex16 wired as x4 Slot (BLACK) (Voltage supported 3.3/12V)	1	1	1	
Height (inches/centimeters)	4.376 / 11.115	2.731 /6.89	2.731 /6.89	
Length (inches/centimeters)	6.6 / 16.765	6.6 /16.765	6.6/16.765	
Maximum Wattage	25W	25W	25W	
PCle x1 Slot (Voltage supported 3.3V/12V)	1	1		
Height (inches/centimeters)	4.376 / 11.115	2.731 / 6.89		
Length (inches/centimeters)	4.5 / 11.44	4.5 / 11.44		
Maximum Wattage	10W	10W		
Mini PCle x1 Slot				1

<sup>\*</sup> Card length can be longer than standard Half-Length Card but cannot be a Full-Length Card.

# SYSTEM LEVEL ENVIRONMENTAL AND OPERATING CONDITIONS

	MT	DT	SFF	USFF
Temperature				
Operating		10° to 35° C	(50° to 95° F)	
Non-Operating (Storage)		-40° to 65° C (	-40° to -149° I	F)
Relative Humidity	:	20% to 80% (r	on-condensin	g)
Maximum vibration				
Operating	0.25	G at 3 to 200	Hz at 0.5 octa	ve/min
Non-Operating	0.5	G at 3 to 200	Hz at 1 octave	e/min
Maximum Shock				
Operating	Bottom ha		vith a change i (20 inches/sec	
Non-Operating	27-G faired square wave with a velocity change of 508 cm/sec (200 inches/sec)			
Maximum Altitude				
Operating	-15.2 to 3048 m (-50 to 10,000 ft)			
Non-Operating	-15	5.2 to 10,668 n	n (-50 to 35,0	00 ft)

#### POWER

NOTE: These form factors utilize a more efficient Active Power Factor Correction (APFC) power supply. Dell recommends only Universal Power Supplies (UPS) based on Sine Wave output for APFC PSUs, not an approximation of a Sine Wave, Square Wave, or quasi-Square Wave. If you have questions, please contact the manu-

	MT		DT		S	USFF	
	APFC	EPA	APFC	EPA	APFC	EPA	EPA
Power Supply Watt- age	265W	265W High Efficiency	250W	250W High Efficiency	240W	240W High Efficiency	200W High Efficiency
AC input Voltage Range	90 – 264Vac	90 – 264Vac	90 – 264Vac	90 – 264Vac	90 – 264Vac	90 – 264Vac	90 – 264Vac
AC input current (low ac range/high AC range)	5.0A / 2.5A	5.0A / 2.5A	4.4A / 2.2A	4.4A / 2.2A	4.0A / 2.0A	4.0A / 2.0A	2.9A / 1.45A
AC input Frequency	47HZ / 63HZ	47HZ / 63HZ	47HZ / 63HZ	47HZ / 63HZ	47HZ / 63HZ	47HZ / 63HZ	47 – 63 Hz
AC holdup time (80% load)	16MSEC	16MSEC	16MSEC	16MSEC	16MSEC	16MSEC	16 ms
Average Efficiency (Energy Star 5.0 Compliant)		87 – 90 – 87% @ 20 – 50 – 100% load		87 – 90 – 87% @ 20 – 50 – 100% load		87 – 90 – 87% @ 20 – 50 – 100% load	87 – 90 – 87% @ 20 – 50 – 100% load
Typical Efficiency (Active PFC)	65%		65%		65%		N/A
DC parameters							
+3.3v output	10.0A	10.0A	7.0 A	7.0 A	3.5A	3.5A	N/A
+5.0v output	13A	13A	15A	15A	11A	11A	N/A
+12.0v output	12VA/17A; 12VB/9A	12VA/17A; 12VB/9A	17.8A	17.8A	17A	17A	+12VA - 12.5 A & +12VB - 6.0 A Note: +12VB Rated at 0.4A when in Standby Mode.
+5.0v auxiliary output	4.0A	4.0A	4.0	4.0	4.0A	4.0A	N/A
-12.0v output	0.5A	0.5A	0.5A	0.5A	0.5A	0.5A	0.1 A
Max total power	265W	265W	255W	255W	235W	235W	200W
Max combined +3.3v / +5.0v power	90W	90W	90W	90W	60W	60W	N/A
Max combined 12.0v power (note: only if more than one 12v rail)	240W	240W	N/A	N/A	N/A	N/A	200W
BTUs/h (based on PSU max wattage)	904 BTU	904 BTU	853 BTU	853 BTU	819 BTU	819 BTU	682 BTU
Power Supply Fan	80*25mm	80*25mm	80*20/25m m	80*20/25m m	60*25mm	60*25mm	N/A
Compliance:							
1watt requirement	Yes	Yes	Yes	Yes	Yes	Yes	Yes
Blue Angel Compliant	Yes	Yes	Yes	Yes	Yes	Yes	Yes
Climate Savers / 80Plus Compliant	No	Yes	No	Yes	No	Yes	Yes
FEMP (CECP) Standby Power Compliant	Yes	Yes	Yes	Yes	Yes	Yes	Yes

#### POWER

NOTE: These form factors utilize a more efficient Active Power Factor Correction (APFC) power supply. Dell recommends only Universal Power Supplies (UPS) based on Sine Wave output for APFC PSUs, not an approximation of a Sine Wave, Square Wave, or quasi-Square Wave. If you have questions, please contact the manufacture to confirm the output type.

3.0v CMOS battery	y (Type and estimate	ed battery	life)	
Brand	Туре	Voltage	Composition	Life
PANASONIC	CR-2032L/BE	3V	Lithium	Continuous Discharge Under 15 kΩ Load to 2.5V End-Voltage. 20□±2□.1183Hrs. or Longer.1133Hrs.or Longer after 12 months.
MITSUBISHI	CR2032	3V	Lithium	Continuous Discharge Under 15 kΩ Load to 2.0V End-Voltage. 20□±2□.1000Hrs. or Longer.970Hrs.or Longer after 12 months. 0□±2□. 910Hrs. or Longer.890Hrs.or Longer after 12 months.

# AUDIO

INTEGRATED REALTEK ALC269Q HIGH DEFINITION AUDIO	МТ	DT	SFF	USFF		
High Definition Stereo support	Х	Х	Х	Х		
Number of channels			2			
Number of Bits / Audio resolution		16, 20, and 2	24-bit resolutio	n		
Sampling rate (recording/playback)	Support	44.1K/48K/96	K/192 kHz sa	mple rates		
Signal to Noise Ratio	98 dB	DAC outputs,	90 dB for AD	C inputs		
Analog Audio	Х	Х	Х	Х		
Dolby Digital						
тнх						
Digital out (S/PDIF)						
Audio Jack Impedance						
Microphone		40K ohm	n∼60K ohm			
Line-In		40K ohm~60K ohm				
Line-Out	100~150 ohm					
Headphone	1~4 ohm					
Internal Speaker Power Rating	2Watt (peak) / 1Watt (average)					

# COMMUNICATIONS - NETWORK ADAPTER (NIC)

NOTE: MT supports full height card, DT supports low profile card. SFF supports low profile card.

INTEGRATED INTEL® 82579 GIGABIT1 ETHERNET LAN 10/100/1000	МТ	DT	SFF	USFF	
External Connector Type	RJ45				
Data Rates supported		10/100/1	1000 Mbps		
Controller Details					
Controller bus architecture	PCIe-bas		or S0 state, SMBu wer state	s for Sx	
Integrated memory		١	N/A		
Data transfer mode (example Bus-Master DMA)		Ŋ	N/A		
Power consumption (full operation per data rate connection speed)		711mV	V (Max.)		
Power consumption (standby operation)		227mV	V (Max.)		
IEEE standards compliance (example 802.1P)	802.3				
Hardware Certifications (example FCC, B, GS mark)	N/A				
Boot ROM Support	EEPROM (located in SPI)				
Network Transfer Mode (example Full Duplex, Half Duplex)					
Network Transfer Rate (example 10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps	10 Mb (full/half-duplex) 100 Mb (full/half-duplex) 1000 Mb (full-duplex)				

COMMUNICATIONS - NETWORK ADAPTER (NIC) (CONT.)

INTEGRATED INTEL® 82579 GIGABIT1 ETHERNET LAN 10/100/1000 (CONT.)	МТ	DT	SFF	USFF			
Environmental							
Operating temperature	0° C to 85° C (32° F to 185° F)						
Operating humidity	20% to 80% (non-condensing)						
Operating System Driver Support	Windows XP, Windows Vista SP2,Windows 7						
Manageability (examples WOL, PXE)	WOL, PXE 2.1						
Management Capabilities Alerting	Intel® Standard Manageability						

<sup>&</sup>lt;sup>1</sup> This term does not connote an actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

## COMMUNICATIONS - INTEGRATED LAN

NOTE: MT supports full height card, DT supports low profile card. SFF supports low profile card.

Broadcom NetXtreme 10/100/1000 PCIe Gigabit <sup>1</sup> Networking Card	МТ	DT	SFF	USFF		
Connector Type		RJ45				
Data Rates supported	10	/100/1000 Mb <sub>l</sub>	ps Half/Full du	plex		
Controller Details						
Controller bus architecture (example PCle 1.0a x1)		PCIe o	c1.0a x1			
Integrated memory		64KBytes RX	X, 8KBytes TX	,		
Data transfer mode (example Bus-Master DMA)		Bus-Ma	ster DMA			
Power consumption (full operation per data rate connection speed)		2.84W (860	mA @ +3.3V)			
Power consumption (standby operation)		Less tha	ın 300mW			
IEEE standards compliance (example 802.1P)		802.3, 802.2,	802.3x, 802.1	р		
Hardware Certifications (example FCC, B, GS mark)		FCC B, V	CCI B, CE			
Boot ROM Support		1	No			
Network Transfer Mode (example Full Duplex, Half Duplex)		Full Duplex/Half Duplex				
Network Transfer Rate (example 10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps	10BASE-T (full-duplex) 20 Mbps Max* 100BASE-TX (half-duplex) 100 Mbps Max* 100BASE-TX (full-duplex) 200 MbpsMax* 1000BASE-T (full-duplex) 2000 Mbps Max* * Depends on the system environment.					

<sup>&</sup>lt;sup>1</sup> This term does not connote an actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

COMMUNICATIONS - INTEGRATED LAN (CONT.)

BROADCOM NETXTREME 10/100/1000 PCIE GIGABIT <sup>1</sup> NETWORKING CARD (CONT.)		МТ	DT	SFF	USFF		
Environmental							
Operating temperature		0° C to 55° C (32° F - 131° F)					
Operating humidity		5% ~ 85% (non-condensing)					
Operating System Driver Support		Windows® 7, Windows® XP, Windows Vista® Ultimate, Windows Vista® Business 32 bit/64 bit, Windows Vista Home Basic, Linux					
Manageability (examples WOL, PXE)		WOL, PXE2.1, ACPI					
Management Capabilities Alerting (example ASF 2.0)	_	None					

<sup>&</sup>lt;sup>1</sup> This term does not connote an actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

## COMMUNICATIONS - WIRELESS

NOTE: Native DisplayPort on system is not supported with optional wireless card on the DT and SFF chassis.

DELL WIRELESS 1520 PCIE MINI PCIE WLAN CARD (802.11N)	МТ	DT	SFF	USFF					
External Connector Type	Custom WLAN Antenna Connector								
Controller Details	Controller Details								
Controller bus architecture	Electrically compatible with the PCI Express Base Specification v1.1 (x1 lane) and PCIe v1.0a.								
WLAN standards supported	8	02.11a, 802.11b, 8	802.11g, 802.11n						
802.11b Data Rates supported		11, 5.5, 2,	1 Mbps						
802.11a Data Rates supported		54, 48, 36, 24, 18	s, 12, 9, 6 Mbps						
802.11g Data Rates supported		54, 48, 36, 24, 18	s, 12, 9, 6 Mbps						
802.11n Data Rates supported	300, 270, 243, 240, 180, 150, 144, 135, 130, 120, 117, 115.5, 90, 86.667, 72.2, 65, 60, 57.8, 45, 43.3, 30, 28.9, 21.7, 15, 14.4 7.2 Mbps								
Encryption		WEP 64-bit a TKIP, AES-CO	,						
Operating temperature	0 to +70 °C								
Operating humidity	Max Operating Humidity 85 %								
Operating System Driver Support	Windows 7, Windows XP 32/64, Vista 32/64								

## COMMUNICATIONS - USB 3.0 ADD-IN CARD

NOTE: MT supports full height (FH) cards and DT and SFF supports low profile (LP) cards.

USB 3.0 PORT PCIE ADD-IN CARD	МТ	DT	SFF	USFF	
Connector Type	PCI Express Gen. 2.0 X1				
Controller Details					
Controller bus architecture (example PCIe 1.0a x1)	PCI Express one lane (x1)				
Chipset		NE	C μPD720200	)	
IO Ports		2 *	USB3.0 port		
Power Consumption		U	Inder 30 mA		
Connector		US	B 3.0 A Type		
Full height USB3.0 add-in card	Optional				
Half height USB3.0 add-in card	Optional				
OS Support	Win XP, Win Vista and Win 7				

COMMUNICATIONS - SERIAL / PARALLEL PORT PCIE ADD-IN CARD

NOTE: MT supports full height (FH) cards and DT and SFF supports low profile (LP) cards.

Serial / Parallel port PCIE add-in card	MT	DT	SFF	USFF			
Connector Type	RS-232 and IEEE1284						
Data Rates supported	50bps ~115.	2Kbps (Serial) &f	Maximum 1.8M	Bp(Parallel)			
Controller Details							
Controller bus architecture (example PCle 1.0a x1)		PCI Express o	ne lane (x1)				
Driver Support	Microsoft Client XP/Vista/7 (X86/X64) Microsoft Server 2000/2003/2008 (X86/X64) Microsoft Embedded XP Embedded/POS Ready 2009/ Embedded System 2009 Linux Linux 2.4.x/2.6.x DOS DOS						
Full height Serial / Parallel add-in card	Optional						
Environment							
Operation Temperature	0 to 60°C (32 to 140°F)						
Operation Humidity	5 to 95% RH						
Storage Temperature		-20 to 85°C (-	4 to 185°F)				

COMMUNICATIONS - SERIAL PORT PCIE ADD-IN CARD

NOTE: MT supports full height (FH) cards and DT and SFF supports low profile (LP) cards.

Low Profile Parallel port PCIE add-in card	MT	DT	SFF	USFF		
Connector Type	IEEE1284					
Data Rates supported		Maximu	ım 1.8MBp			
Controller Details						
Controller bus architecture (example PCle 1.0a x1)	PCI Express one lane (x1)					
Driver Support	Microsoft Client XP/Vista/7 (X86/X64) Microsoft Server 2000/2003/2008 (X86/X64) Microsoft Embedded XP Embedded/POS Ready 2009/ Embedded System 2009 Linux Linux 2.4.x/2.6.x DOS DOS					
Half height Serial add-in card		Opti	ional			
Environment						
Operation Temperature	0 to 60°C (32 to 140°F)					
Operation Humidity	5 to 95% RH					
Storage Temperature		-20 to 85°C	(-4 to 185°F)			

## GRAPHICS/VIDEO CONTROLLER

NOTE: MT supports full height card, DT supports low profile card. SFF supports low profile card.

Onboard Graphics.  1. Intel HD Graphics [with Celeron/Pentium class CPU-GPU combo]  2. Intel HD Graphics 2000 [with iCore Dual/Quad core class CPU-GPU combo]	МТ	DT	SFF	USFF
Bus Type	Integrated			
GPU core clock	Gen6 Core Intel® HD Graphics /HD Graphics 2000 @ 850MHz			raphics 2000
Frame Buffer Memory (onboard and shared) Size and Speed	Depends on available system memory(Up to 1.7GB with 4GB system Memory)			
Overlay Planes	Yes			
Maximum Color Depth	32 bit			
Maximum Vertical Refresh Rate	75 Hz			
Multiple Display Support	Yes			
Operating Systems Graphics/ Video API Support	OpenGL 3.0/DirectX 10.1			
Supported Resolutions and Max Refresh Rates (Hz) (Note: Analog and/or digital)	Up to 2560x1600 @ 60Hz (DP) Up to 1920x1200 @ 60Hz (DVI & HDMI) Up to 2048x1536 @ 75Hz (VGA only)			
External Connectors	VGA, DisplayPort			
<u>DisplayPort</u>				
Bus Type	DDPC			
Maximum supported resolution	Up to 2560x1600 @ 60Hz			
Maximum power consumption	N/A			
External connectors	DisplayPort			
DisplayPort Audio Support	Yes			

<sup>&</sup>lt;sup>1</sup>Up to 1.7 GB of system memory may be allocated to support integrated graphics, depending on operating system, system memory size and other factors.

<sup>2</sup> DVI and VGA can be used concurrently for multi-monitor display in DOS. The DisplayPort controller does not support multi-monitor display in DOS

# GRAPHICS/VIDEO CONTROLLER (CONT.)

1GB AMD RADEON™ HD6450	MT	DT	SFF
Bus Type (example integrated or PCle x16)	PCIEx16		
GPU core clock	625Mhz		
Frame Buffer Memory (onboard and shared) Size and Speed	800Mhz		
Maximum power consumption		20W	
Overlay Planes	Yes		
Maximum Color Depth	32-bit		
Maximum Vertical Refresh Rate	85Hz		
Multiple Display Support	Yes		
Operating Systems Graphics/ Video API Support	DX11 and OpenGL3		
Supported Resolutions and Max Refresh Rates (Hz) (Note: Analog and/or digital)	Dual-Link DVI Max: 2560 x 1600/32bpp @ 75Hz DispalyPort Max: 2560 x 1600/32bpp @ 75Hz VGA Max : 1920x1440/32bpp @ 75Hz Min : 640x480/8bpp @ 60Hz		
External connectors	1 DVI-I and 1 DisplayPort		
DisplayPort Audio Support	Yes		
Dimensions of full height card inches/centimeters (L x H)	6.6 x 4.7 / 16.764 x 12.0		
Dimensions of low profile card inches/centimeters (L x H)		6.6 x 3.35 / 1	6.764 x 8.5
Environmental Operating Conditions (Non-Condensing):			
Operating Temperature Range	10°-50° C		
Relative Humidity Range	5-90% RH		
Altitude Range	0-20,000 ft.		

512MB AMD RADEON™ HD6350	MT	DT	SFF
Bus Type (example integrated or PCle x16)	PCIEx16		
GPU core clock	650Mhz		
Frame Buffer Memory (onboard and shared) Size and Speed		800Mhz	
Maximum power consumption	20W		
Overlay Planes	Yes		
Maximum Color Depth	32-bit		
Maximum Vertical Refresh Rate	85Hz		
Multiple Display Support	Yes		
Operating Systems Graphics/ Video API Support	DX11 and OpenGL3		
Supported Resolutions and Max Refresh Rates (Hz) (Note: Analog and/or digital)	DVI Max : 1920x1200/32bpp @ 75Hz VGA Max: 1920x1440/32bpp @ 75Hz Min : 640x480/8bpp @ 60Hz		
External connectors	1 DMS59 (DVI x2 or VGA x2)		
Dimensions of full height card inches/centimeters (L x H)	6.6 x 2.731 / 16.764 x 6.936		
Dimensions of low profile card inches/centimeters (L x H)		6.6 x 2.731 / 1	6.764 x 6.936
Environmental Operating Conditions (Non-Condensing):			
Operating Temperature Range	10°-50° C		
Relative Humidity Range	5-90% RH		
Altitude Range	0-20,000 ft.		

## HARD DRIVES

3.5" 1TB SATA 7200 RPM HDD		
Capacity (bytes)	1,000,204,886,016	
<b>Dimensions</b> inches (W x D x H)	5.87 x 4 x 1	
Interface type and Maximum speed	Up to 6Gb/s (SATA 3.0) Up to 3Gb/s (SATA 2.0)	
Internal buffer size	32 MB	
Average Seek Time	8.5 ms	
Rotational Speed	7200 rpm	
Logical Blocks	1,953,525,168	
Power Source		
Power Consumption (reference only)	Idle 5.0W, Active 10.0W(running IOmeter utility)	
Spin Up Current (reference only)	5V (1A) ,12V (2A)	
Environmental Operating Conditions (Non-Condensing):		
Temperature Range	5°C to 60°C	
Relative Humidity Range	20% to 80% non-condensing	
Maximum Wet Bulb Temperature	29°C	
Altitude Range	-50 ft to 10000 ft	
Environmental Non-Operating Conditions (Non-Condensing):		
Temperature Range	-40°C to 65°C	
Relative Humidity Range	10% to 90% non-condensing	
Maximum Wet Bulb Temperature	38°C	
Altitude Range	-50 ft to 35000 ft	

<sup>&</sup>lt;sup>1</sup> For hard drives, GB means 1 billion bytes; actual capacity varies with preloaded material and operating environment and will be less.

3.5" 500GB SATA 7200 RPM HDD		
Capacity (bytes)	500,107,862,016	
<b>Dimensions</b> inches (W x D x H)	5.87 x 4 x 1	
Interface type and Maximum speed	Up to 6Gb/s (SATA 3.0) Up to 3Gb/s (SATA 2.0)	
Internal buffer size	16 MB	
Average Seek Time	8.5 ms	
Rotational Speed	7200 rpm	
Logical Blocks	976,773,168	
Power Source		
Power Consumption (reference only)	Idle 5.0W, Active 10.0W(running IOmeter utility)	
Spin Up Current (reference only)	5V (1A) ,12V (2A)	
Environmental Operating Conditions (Non-Condensing):		
Temperature Range	5°C to 60°C	
Relative Humidity Range	20% to 80% non-condensing	
Maximum Wet Bulb Temperature	29°C	
Altitude Range	-50 ft to 10000 ft	
Environmental Non-Operating Conditions (Non-Condensing):		
Temperature Range	-40°C to 65°C	
Relative Humidity Range	10% to 90% non-condensing	
Maximum Wet Bulb Temperature	38°C	
Altitude Range	-50 ft to 35000 ft	

<sup>&</sup>lt;sup>1</sup> For hard drives, GB means 1 billion bytes; actual capacity varies with preloaded material and operating environment and will be less.

3.5" 320GB SATA 7200 RPM HDD		
Capacity (bytes)	320,072,933,376	
Dimensions inches (W x D x H)	5.87 x 4 x 1	
Interface type and Maximum speed	Up to 6Gb/s (SATA 3.0) Up to 3Gb/s (SATA 2.0)	
Internal buffer size	16 MB	
Average Seek Time	8.5 ms	
Rotational Speed	7200 rpm	
Logical Blocks	625,142,448	
Power Source		
Power Consumption (reference only)	Idle 5.0W, Active 10.0W(running IOmeter utility)	
Spin Up Current (reference only)	5V (1A) ,12V (2A)	
Environmental Operating Conditions (Non-Condensing):		
Temperature Range	5°C to 60°C	
Relative Humidity Range	20% to 80% non-condensing	
Maximum Wet Bulb Temperature	29°C	
Altitude Range	-50 ft to 10000 ft	
Environmental Non-Operating Conditions (Non-Condensing):		
Temperature Range	-40°C to 65°C	
Relative Humidity Range	10% to 90% non-condensing	
Maximum Wet Bulb Temperature	38°C	
Altitude Range	-50 ft to 35000 ft	

<sup>&</sup>lt;sup>1</sup> For hard drives, GB means 1 billion bytes; actual capacity varies with preloaded material and operating environment and will be less.

3.5" 250GB SATA 7200 RPM HDD		
Capacity (bytes)	250,059,350,016	
<b>Dimensions</b> inches (W x D x H)	5.87 x 4 x 1	
Interface type and Maximum speed	Up to 6Gb/s (SATA 3.0) Up to 3Gb/s (SATA 2.0)	
Internal buffer size	8 MB	
Average Seek Time	8.5 ms	
Rotational Speed	7200 rpm	
Logical Blocks	488,397,168	
Power Source		
Power Consumption (reference only)	Idle 5.0W, Active 10.0W(running IOmeter utility)	
Spin Up Current (reference only)	5V (1A) ,12V (2A)	
Environmental Operating Conditions (Non-Condensing):		
Temperature Range	5°C to 60°C	
Relative Humidity Range	20% to 80% non-condensing	
Maximum Wet Bulb Temperature	29°C	
Altitude Range	-50 ft to 10000 ft	
Environmental Non-Operating Conditions (Non-Condensing):		
Temperature Range	-40°C to 65°C	
Relative Humidity Range	10% to 90% non-condensing	
Maximum Wet Bulb Temperature	38°C	
Altitude Range	-50 ft to 35000 ft	

<sup>&</sup>lt;sup>1</sup> For hard drives, GB means 1 billion bytes; actual capacity varies with preloaded material and operating environment and will be less.

2.5" 500GB SATA 7200 RPM HDD		
Capacity (bytes)	500,107,862,016	
<b>Dimensions</b> inches (W x D x H)	Approximately (3.93 x 2.75 x 0.374 inches)	
Interface type and Maximum speed	Up to 3Gb/s	
Internal buffer size	16 MB	
Average Seek Time	12 ms (Read)	
Rotational Speed	7200 rpm	
Logical Blocks	976,773,168	
Power Source		
Power Consumption (reference only)	Idle 0.7W, Active 3.25W	
Spin Up Current (reference only)	5V (1A)	
Environmental Operating Conditions (Non-Condensing):		
Temperature Range	5°C to 60°C	
Relative Humidity Range	20% to 80% non-condensing	
Maximum Wet Bulb Temperature	29°C	
Altitude Range	-50 ft to 10000 ft	
Environmental Non-Operating Conditions (Non-Condensing):		
Temperature Range	-40°C to 65°C	
Relative Humidity Range	10% to 90% non-condensing	
Maximum Wet Bulb Temperature	38°C	
Altitude Range	-50 ft to 35000 ft	

<sup>&</sup>lt;sup>1</sup> For hard drives, GB means 1 billion bytes; actual capacity varies with preloaded material and operating environment and will be less.

2.5" 500GB SATA 7200 RPM HYBRID HDD		
Capacity (bytes)	500,107,862,016	
<b>Dimensions</b> inches (W x D x H)	Approximately (3.93 x 2.75 x 0.374 inches)	
Interface type and Maximum speed	Up to 3Gb/s	
Internal buffer size	16 MB	
Average Seek Time	12 ms (Read)	
Rotational Speed	7200 rpm	
Logical Blocks	976,773,168	
Power Source		
Power Consumption (reference only)	Idle 0.8W, Active 3.25W	
Spin Up Current (reference only)	5V (1A)	
Environmental Operating Conditions (Non-Condensing):		
Temperature Range	5°C to 60°C	
Relative Humidity Range	20% to 80% non-condensing	
Maximum Wet Bulb Temperature	29°C	
Altitude Range	-50 ft to 10000 ft	
Environmental Non-Operating Conditions (Non-Condensing):		
Temperature Range	-40°C to 65°C	
Relative Humidity Range	10% to 90% non-condensing	
Maximum Wet Bulb Temperature	38°C	
Altitude Range	-50 ft to 35000 ft	

<sup>&</sup>lt;sup>1</sup> For hard drives, GB means 1 billion bytes; actual capacity varies with preloaded material and operating environment and will be less.

320,072,933,376		
5.87 x 4 x 1 (includes sled)		
Up to 3Gb/s		
16 MB		
8.5 ms		
7200 rpm		
625,142,448		
Idle 0.7W, Active 3.25W		
5V (1A)		
Environmental Operating Conditions (Non-Condensing):		
5°C to 60°C		
20% to 80% non-condensing		
29°C		
-50 ft to 10000 ft		
Environmental Non-Operating Conditions (Non-Condensing):		
-40°C to 65°C		
10% to 90% non-condensing		
38°C		
-50 ft to 35000 ft		

<sup>&</sup>lt;sup>1</sup> For hard drives, GB means 1 billion bytes; actual capacity varies with preloaded material and operating environment and will be less.

HARD DRIVES (CONT.)

2.5" 250GB SATA 7200 RPM HDD	
Capacity (bytes)	250,059,350,016
<b>Dimensions</b> inches (W x D x H)	Approximately (3.93 x 2.75 x 0.374 inches)
Interface type and Maximum speed	Up to 3Gb/s
Internal buffer size	16 MB
Average Seek Time	12 ms (Read)
Rotational Speed	7200 rpm
Logical Blocks	488,397,168
Power Source	
Power Consumption (reference only)	Idle 0.7W, Active 3.25W
Spin Up Current (reference only)	5V (1A)
Environmental Operating Conditions (Non-Condensing):	
Temperature Range	5°C to 60°C
Relative Humidity Range	10% to 90% non-condensing
Maximum Wet Bulb Temperature	29°C
Altitude Range	-50 ft to 10000 ft
Environmental Non-Operating Conditions (Non-Condensing):	
Temperature Range	-40°C to 65°C
Relative Humidity Range	10% to 90% non-condensing
Maximum Wet Bulb Temperature	38°C
Altitude Range	-50 ft to 35000 ft

<sup>&</sup>lt;sup>1</sup> For hard drives, GB means 1 billion bytes; actual capacity varies with preloaded material and operating environment and will be less.

HARD DRIVES (CONT.)

2.5" 128GB <sup>1</sup> SATA SOLID STATE DRIVE	
Capacity (bytes)	128,035,676,160
Dimensions inches (W x D x H)	3.94 x 2.75 x 0.374
Interface type and Maximum speed	Up to 6Gb/s (SATA 3.0) Up to 3Gb/s (SATA 2.0)
MTBF	1M hours
Average Seek Time	n/a
Logical Blocks	250,069,680
Power Source	
Power Consumption (reference only)	Idle 1W, Active 1.25W
Spin Up Current (reference only)	5V (1000mA)
Environmental Operating Conditions (Non-Condensing):	
Temperature Range	0°C to 70°C
Relative Humidity Range	10 to 90%
Maximum Wet Bulb Temperature	29°C
Altitude Range	-200 to 5,000 m
Op Shock (@0.5ms)	1,500G
Environmental Non-Operating Conditions (Non-Condensing):	
Temperature Range	-55°C to 95°C
Relative Humidity Range	5 to 95%
Maximum Wet Bulb Temperature	38°C
Altitude Range	-200 to 10,600 m

<sup>&</sup>lt;sup>1</sup> For hard drives, GB means 1 billion bytes; actual capacity varies with preloaded material and operating environment and will be less.

# OPTICAL DRIVES

DVD +/- RW <sup>1</sup>	MT	DT	SFF	USFF
External Dimensions inches/centimeters (Without Bezel – W x H x D)	148.2mm(6in)/42mm (2in)/ 190.5 (max)	148.2mm(6in)/42mm (2in)/ 190.5 (max)	128.0 mm (5.04)/ 12.7mm (0.5 in)/ 126.1mm (4.97in)	128.0 mm (5.04)/ 12.7mm (0.5 in)/ 126.1mm (4.97in)
Weight (max) pounds/ kilograms	800g	800g	170g	170g
Interface type and speed	SATA 1.5Gbit/s	SATA 1.5Gbit/s	SATA 1.5Gbit/s	SATA 1.5Gbit/s
Disc Capacity	Standard	Standard	Standard	Standard
Internal buffer size	supplier dependent	supplier dependent	supplier dependent	supplier dependent
Access Times (typical)	supplier dependent	supplier dependent	supplier dependent	supplier dependent
Maximum Data Transfer Ra	ntes			
Writes	16x DVD/48x CD	16x DVD/48x CD	8x DVD/ 24x CD	8x DVD / 24x CD
Reads	16x DVD/48x CD	16x DVD/48x CD	8x DVD/ 24x CD	8x DVD/ 24x CD
Power Source				
DC Power Requirements	12V, 5V	12V, 5V	5V	5V
DC Current	1200mA (12V)/ 900mA (5V)	1200mA (12V)/ 900mA (5V)	1000mA	1000mA
Environmental Operating C	Conditions (Non-Condensing	):		
Operating Temperature Range	5C to 50C	5C to 50C	5C to 50C	5C to 50C
Relative Humidity Range	20% to 80% RH	20% to 80% RH	20% to 80% RH	20% to 80% RH
Maximum Wet Bulb Temperature	29C	29C	29C	29C
Altitude Range	-200 to 3048	-200 to 3048	-200 to 3048	-200 to 3048
Environmental Non-Operat	ing Conditions (Non-Conden	sing):		
Operating Temperature Range	-40C to 65C	-40C to 65C	-40C to 65C	-40C to 65C
Relative Humidity Range	5% to 95% RH	5% to 95% RH	5% to 95% RH	5% to 95% RH
Maximum Wet Bulb Temperature	38C	38C	38C	38C
Altitude Range	-200 to 10600m	-200 to 10600m	-200 to 10600m	-200 to 10600m

<sup>&</sup>lt;sup>1</sup> Discs burned with this drive may not be compatible with some existing drives and players; using DVD+R media provides maximum compatibility.

DVD-ROM	-ROM <b>MT</b>		SFF	USFF	
External Dimensions inches/centimeters (Without Bezel – W x H x D)	148.2mm(6in)/42mm (2in)/ 190.5 (max) 148.2mm(6in)/42mm (2in)/ 190.5 (max) 128.0 mm (5.04)/ 12.7mm (0.5 in)/ 126.1mm (4.97in)				128.0 mm (5.04)/ 12.7mm (0.5 in)/ 126.1mm (4.97in)
Weight (max) pounds/ kilograms	750g	750g	165g 165g		
Interface type and speed	SATA 1.5Gbit/s	SATA 1.5Gbit/s	SATA 1.5Gbit/s	SATA 1.5Gbit/s	
Disc Capacity	Standard Standard		Standard	Standard	
Internal buffer size	buffer size supplier dependent supplier dependent		supplier dependent	supplier dependent	
Access Times (typical)	supplier dependent	supplier dependent	supplier dependent	supplier dependent	
Maximum Data Transfer Ra	ites				
Writes	N/A	N/A	N/A	N/A	
Reads	16x DVD/48x CD	16x DVD/48x CD	8x DVD/ 24x CD	8x DVD/ 24x CD	

OPTICAL DRIVES (CONT.)

DVD-ROM (CONT.)	MT DT		SFF	USFF
Power Source				
DC Power Requirements	12V, 5V	12V, 5V	5V	5V
DC Current	1200mA (12V)/ 900mA (5V)	1200mA (12V)/ 900mA (5V)	800mA	800mA
Environmental Operating C	Conditions (Non-Condensing	):		
Operating Temperature Range	5C to 50C	5C to 50C	5C to 50C	5C to 50C
Relative Humidity Range	20% to 80% RH	20% to 80% RH 20% to 80% F		20% to 80% RH
Maximum Wet Bulb Temperature	29C	29C	29C	29C
Altitude Range	-200 to 3048m	-200 to 3048m -200 to 3048m		-200 to 3048m
Environmental Non-Operat	ing Conditions (Non-Conder	sing):		
Operating Temperature Range	-40C to 65C	-40C to 65C	-40C to 65C	-40C to 65C
Relative Humidity Range	5% to 95% RH	5% to 95% RH	5% to 95% RH	5% to 95% RH
Maximum Wet Bulb Temperature	38C	38C	38C	38C
Altitude Range	-200 to 10600m	-200 to 10600m	-200 to 10600m	-200 to 10600m

# SECURITY

DELL DATA PROTECTI TION ENGINE	ON   ENCRYP-	MT DT SFF USF			
Controller bus architecture		PCI Express one lane (x1)			
Chip		STM7007			
Power consumption	Operational typical	411mW			
1 Ower consumption	Idle typical				
Connector		PCI Express Gen 2.0 X1			
Form factor		Full height Half height Half height PEX PEX PEX			
OS Support		Win XP, Win Vista and Win 7			

# MEDIA CARD READER (MCR)

NOTE: Dell 19 in 1 Media Card Reader (MCR) is supported via a F5 to F3 bay converter on the MT and DT and may require a slim line optical drive depending on selectable configuration. MCR is not available on the SFF and USFF chassis.

MT/DT
3.99/(10.13cm)/1.0/(2.54cm)
~155g
USB 2.0, 480Mb/s
lash Media Types)
CF I CF II Micro Drive (MD) Secure Digital (SD) SDHC Mini Secure Digital (mini-SD) Micro Secure Digital (Micro-SD)(with adapter) Multi Media Card (MMC) RS Multi Media Card (RS-MMC) Multi Media Card plus (MMC plus) RS Multi Media Card plus (RS-MMC plus) RS Multi Media Card plus (RS-MMC plus) Multi Media Card Micro (MMC Micro) (with adapter) Memory Stick (MS) Memory Stick Pro (MS Pro) Memory Stick Pro Duo (MS-Pro Duo) Memory Stick Micro)(MS-Duo) Memory Stick Micro (MS Micro) (with adapter) Smart Media (SM) xD
Compact Flash type I/II Version 4.0 Smart Media (SM) Specification 2003 Multi Media Card (MMC) Specification 4.2 Secure Digital (SD) 2.0 Memory Stick Pro (MS-PRO) Specification 1.02 Memory Stick (MS) Specification 1.43 xD Specification 1.2
12V, 5V
4.75V ~ 5.25V
Standby less than 0.5mA @ 5.0VDC
5C to 50C
10% to 90% RH
y):
-40C to 65C

# BIOS DEFAULTS

System Configuration	Integrated NIC:	Enable
3	USB Controller:	Enable or disable
	Serial Port:	COM1
	SATA Operation:	AHCI
		Enable or disable the integrated USB
		Controller for:  Boot support
		Rear Dual USB Ports
		●Front USB Ports
	USB Controller:	Rear Quad USB Ports
	SMART Reporting:	Disable
	Diskette Drive:	Enable
	Miscellaneous Devices:	Enables or disables the Wi-Fi Radio
	iviiscellarieous Devices.	Enable (SATA-0, SATA-1, SATA-2, SATA
	Drives:	-3)
Video	Primary Video:	Auto
Performance	Multiple Core Support:	All
	Intel® SpeedStep™:	Enable
	C States Control:	Disable
	Limit CPUID Value:	Enable
	HyperThread control:	Enable
	31	
Virtualization Support	Virtualization:	Enable
	VT for Direct I/O:	Disable
Security	Administrator Password:	Not set
	System Password:	Not set
	Password Changes:	Enable
	TPM Security:	Disable
	CPU XD Support:	Enable
	Computrace®:	Deactivate
	SATA-0 Password:	Not set
Power Management	AC Recovery:	Power Off
	Auto On Time:	Disable
	Deep Sleep Control:	Disable
	Fan Control Override:	Disable
	Wake on LAN:	Disable
Maintenance	Service Tag:	Set by the factory
wantenance	Asset Tag:	Optional User Entry
	SERR Message:	Enable
	, <u></u>	
	Numlock LED:	Enable
	USB Emulation:	Enable
	Keyboard Errors:	Enable
	POST HotKeys:	Enable
	Fast Boot:	Thorough 42
		12

#### CHASSIS ENCLOSURE & VENTILATION REQUIREMENTS

#### **ENCLOSURE VENTILATION**

If your enclosure has doors, they need to be of a type that allows at least 30% airflow through the enclosure (front and back).

#### ENCLOSURE MINIMUM CLEARANCE

Leave a 10.2 cm (4 in.) minimum clearance on all vented sides of the computer to permit the airflow required for proper ventilation.

#### RECOMMENDED ENCLOSURE

Do not install your computer in an enclosure that does not allow airflow. This restricts the airflow and impacts your computer's performance, possibly causing it to overheat.



#### OPEN DESK MINIMUM CLEARANCE

If your computer is installed in a corner, on a desk, or under a desk, leave at least 5.1 cm (2 in.) clearance from the back of the computer to the wall to permit the airflow required for proper ventilation.



## REGULATORY COMPLIANCE AND ENVIRONMENTAL

Product related conformity assessment and regulatory authorizations including Product Safety, Electromagnetic Compatibility (EMC), Ergonomics, and Communication Devices relevant to this product may be viewed at www.dell.com/regulatory\_compliance. The Regulatory Datasheet for this product is located at <a href="http://www.dell.com/regulatory\_compliance">http://www.dell.com/regulatory\_compliance</a>.

Details of Dell's environmental stewardship program to conserve product energy consumption, reduce or eliminate materials for disposal, prolong product life span and provide effective and convenient equipment recovery solutions may be viewed at www.dell.com/environment. Product related conformity assessment, regulatory authorizations, and information encompassing Environmental, Energy Consumption, Noise Emissions, Product Materials Information, Packaging, Batteries, and Recycling relevant to this product may be viewed by clicking the Design for Environment link on the webpage.

Reduce energy consumption, save money		Notes
Energy efficient design: Allowing you compute more, and consume less. The Optiergy Star® rated (containing a 80 PLUS® Gold certified power supply) which mean efficient power supplies, operates efficiently in multiple modes (Off, Sleep and Idle) power-management features enabled. This level of efficiency helps you save mone ciated with the use of your product.	ns it uses energy- ), and has advanced	All E-Star Se- lected configs
Compare energy consumption with energy savings calculator: www.dell.com/ene	ergy	All configs
Take control of your energy consumption: Includes Energy Smart Power Managerallows you to configure your computer to ensure the greatest energy saving in Inac		All Energy Smart Selected
Reduce, Re-use, Recycle		
<b>Recycle responsibly and invest in peace of mind:</b> Protect your company's sensitive responsibly with the Dell Asset Recovery & Recycling Service. Find out how: http://us/en/enterprise/services-asset-recovery-services.aspx?redirect=2		All configs
<b>Protect developing countries from e-waste exports:</b> Because responsible recyclin matters to us. In 2009, Dell was the first in the industry to ban the export of nonwork electronic waste (e-waste) to developing countries. Learn more: http://content.deld/corp-comm/e-waste.aspx	orking electronics or	All configs
Eco-responsible packaging		
Molded paper pulp packaging cushions (where available): Making it easier to choo eco-responsible packaging, this product is cradled in our innovative molded paper know that responsible sourcing is important to you, so our pulp is made with 100% cled cardboard that is sourced near manufacturing operations to the reduce carbo ping.	pulp packaging. We news print or recy-	SFF configs only - regiona disclaimer: only available in US, Canada and Malaysia
Recycled milk jug packaging cushions (where available): Making it easier to choose responsible packaging, this product is cradled in our innovative recylced milk jug H know that responsible sourcing is important to you, so our cushions are made with terial that is sourced near manufacturing operations to the reduce carbon footprin	IDPE packaging. We n 100% recycled ma-	MT and DT configs only - regional dis- claimer: only available in US Canada and Malaysia
<b>Recycled packaging:</b> Helping you to avoid sending unnecessary waste to landfills, with expanded polyethylene cushion packaging material which has a high percent content (20% in APJ, 25% in EMEA and 65% in Americas). Using recycled materials reduction and the conservation of resources.	age of recycled	USFF and re- gional configs not shipping HDPE or Molo ed Paper cush ions
<b>Shipped in recycled materials:</b> To help you reduce waste and reuse potentially use product's box packaging is made with at least 25% recycled post consumer cardbo		All configs
Reduce packaging waste: Dell is implementing a plan to simplify and revolutionize ing that will result in the elimination of approximately 20 million pounds of packag 2008 through 2012. Find out more: http://content.dell.com/us/en/corp/d/corp-coproducts-packaging.aspx. This product is also offered in a multipack configuration	ing materials from omm/earth-	All configs. Multipack is available in the US
Environmentally Preferable Ingredients		
<b>Finding better ingredients:</b> Making it easy for you to reduce your environmental in 790 enclosure plastics are built with a minimum of 10% Post Consumer Recycled C reduced levels of environmentally sensitive materials such as mercury and arsenic		
Meets or exceeds world-wide environmental standards: WW EU RoHS (Lead free) REACH compliant.	, China RoHS and	All configs
EPEAT US/Canada/France , Energy Star, TCO, Blue Angel Learn more about Eco-Labels at http://content.dell.com/us/en/corp/d/corp-comr product-certifications.aspx	m/dell-green-	

## ACOUSTIC NOISE EMISSION INFORMATION

## OPTIPLEX 790 MT

Component	Typical Configuration	High-end Configuration
CPU	Intel I3,3.3GHZ,2c SNB 65W	Intel I5,3.1GHZ , 4c SNB 95W
Memory	2G DDR3 1333MHz	2G DDR3 1333MHz(x2)
HDD (#, capacity)	250G 7200RPM SATA2	500G 7200RPM SATA2(x2)
RMSD	16X DVD+/-RW SATA HH	16X DVD+/-RW SATA HH
Graphics Adapter	Intel® HD Graphics Family	AMD Radeon HD6350

The Declared Noise Emission in accordance with ISO 9296 for the Dell OptiPlex 780 MT is as follows: (all values L<sub>WAd</sub> expressed in bels; 1 bel=10 decibels, re 10<sup>-12</sup> Watts)

Operating Mode	Typical Configuration Declared Sound Power (L <sub>WAd</sub> )	High-end Configuration Declared Sound Power (L <sub>WAd</sub> )	
Idle	3.7	3.9	
HDD Operating	3.9	3.9	
90% CPU	3.8	4.0	
ODD Operating	5.1	5.1	

The Declared A-weighted Sound Pressure Level in decibels (re 2x10<sup>-5</sup> Pa), at Operator, Bystander, and Desk Side Positions are measured in accordance with ISO 7779 7.6.1, 7.6.2, and C.15.2 and declared in accordance with ISO 9296 for this product is as follows1:

Operating Mode	Typical Configuration Declared Sound Pressure (LpA)			High-end Co	onfiguration D (Lp		nd Pressure	
	Table-Top Floor-Standing		Table-Top		Floor- Standing			
	Operator Position (LpA)	Bystander Position (LpA)	Operator Position (LpA)	Bystander Position (LpA)	Operator Position (LpA)	Bystander Position (LpA)	Operator Position (LpA)	Bystand- er Posi- tion (LpA)
Idle	26.5	24.2	21.0	21.2	26.8	24.3	20.9	21.4
HDD Operating	26.7	24.9	21.1	20.9	26.8	23.9	21.8	21.4
90% CPU	26.7	24.8	21.6	21.3	30.0	26.3	22.4	22.0
ODD Operating	39.7	35.8	36.6	36.1	40.7	36.0	35.4	33.5

<sup>&</sup>lt;sup>1</sup> All tests are conducted according to ISO 7779 and declared according to ISO 9296 except 90% CPU. For this mode, the system CPU was stressed at 90% utilization with no other peripheral device actively seeking. This test mode is not specified in ISO 7779, but was measured using the same microphone distances and measurement techniques defined for the other reported operating modes. <sup>2</sup> Declared Sound Power rounded to nearest tenth of a bel per ISO 9296 section 4.4.2

## ACOUSTIC NOISE EMISSION INFORMATION

#### OPTIPLEX 790 DT

Component	Typical Configuration	High-end Configuration
CPU	Intel I3,3.3GHZ,2c SNB 65W	Intel I5,3.1GHZ ,4c SNB 95W
Memory	2G DDR3 1333MHz	2G DDR3 1333MHz(x2)
HDD (#, capacity)	250G 7200RPM SATA2	500G 7200RPM SATA2
RMSD	16X DVD+/-RW SATA HH	16X DVD+/-RW SATA HH
Graphics Adapter	Intel® HD Graphics Family	AMD Radeon HD6350

The Declared Noise Emission in accordance with ISO 9296 for the Dell OptiPlex 780 DT is as follows: (all values  $L_{WAd}$  expressed in bels; 1 bel=10 decibels, re  $10^{-12}$  Watts)

Operating Mode	Typical Configuration Declared Sound Power (L <sub>WAd</sub> )	High-end Configuration Declared Sound Power (L <sub>WAd</sub> )		
Idle	3.7	3.7		
HDD Operating	3.6	3.8		
90% CPU	4.1	4.4		
ODD Operating	5.1	5.1		

The Declared A-weighted Sound Pressure Level in decibels (re 2x10<sup>-5</sup> Pa), at Operator, Bystander, and Desk Side Positions are measured in accordance with ISO 7779 7.6.1, 7.6.2, and C.15.2 and declared in accordance with ISO 9296 for this product is as follows<sup>1</sup>:

Operating Mode	Typical Configuration Declared Sound Pressure (LpA)			High-end Configuration Declared Sound Pressure (LpA)				
	Table-Top Floor-Standing		Table-Top		Floor- Standing			
	Operator Position (LpA)	Bystander Position (LpA)	Operator Position (LpA)	Bystander Position (LpA)	Operator Position (LpA)	Bystander Position (LpA)	Operator Position (LpA)	Bystand- er Posi- tion (LpA)
Idle	24.6	20.7	20.5	19.5	24.9	22.5	21.0	20.9
HDD Operating	24.9	21.2	20.7	19.8	24.2	21.8	21.0	20.9
90% CPU	29.4	24.1	20.8	21.3	33.4	30.7	27.1	26.2
ODD Operating	42.2	36.8	35.1	34.7	41.2	37.2	35.5	33.5

<sup>&</sup>lt;sup>1</sup> All tests are conducted according to ISO 7779 and declared according to ISO 9296 except 90% CPU. For this mode, the system CPU was stressed at 90% utilization with no other peripheral device actively seeking. This test mode is not specified in ISO 7779, but was measured using the same microphone distances and measurement techniques defined for the other reported operating modes. <sup>2</sup> Declared Sound Power rounded to nearest tenth of a bel per ISO 9296 section 4.4.2

## ACOUSTIC NOISE EMISSION INFORMATION

#### **OPTIPLEX 790 SFF**

Component	Typical Configuration	High-end Configuration
CPU	Intel I3,3.3GHZ,2c SNB,65W	Intel I5,3.1GHZ ,4c SNB 95W
Memory	2G DDR3 1333MHz	2G DDR3 1333MHz(x2)
HDD (#, capacity)	250G 7200RPM SATA2	500G 7200RPM SATA2
RMSD	16X DVD+/-RW SATA HH	16X DVD+/-RW SATA HH
Graphics Adapter	Intel® HD Graphics Family	AMD Radeon HD6350

The Declared Noise Emission in accordance with ISO 9296 for the Dell OptiPlex 780 SFF is as follows: (all values L<sub>WAd</sub> expressed in bels; 1 bel=10 decibels, re 10<sup>-12</sup> Watts)

Operating Mode	Typical Configuration Declared Sound Power (L <sub>WAd</sub> )	High-end Configuration Declared Sound Power (L <sub>WAd</sub> )
Idle	3.6	3.9
HDD Operating	3.6	4.0
90% CPU	3.9	4.3
ODD Operating	4.6	4.6

The Declared A-weighted Sound Pressure Level in decibels (re 2x10<sup>-5</sup> Pa), at Operator, Bystander, and Desk Side Positions are measured in accordance with ISO 7779 7.6.1, 7.6.2, and C.15.2 and declared in accordance with ISO 9296 for this product is as follows<sup>1</sup>:

Operating Mode	Typical Configuration Declared Sound Pressure (LpA)			High-end Configuration Declared Sound Pressure (LpA)				
	Table-Top Floor-Standing		Table-Top		Floor- Standing			
	Operator Position (LpA)	Bystander Position (LpA)	Operator Position (LpA)	Bystander Position (LpA)	Operator Position (LpA)	Bystander Position (LpA)	Operator Position (LpA)	Bystander Position (LpA)
Idle	25.3	21.6	19.6	18.6	29.4	25.8	22.1	21.4
HDD Operating	24.7	20.5	20.6	19.9	29.3	25.4	22.7	20.6
90% CPU	28.9	24.2	21.0	21.0	32.9	28.1	27.5	26.5
ODD Operating	36.9	30.6	29.5	27.7	38.0	32.4	33.2	29.6

<sup>&</sup>lt;sup>1</sup> All tests are conducted according to ISO 7779 and declared according to ISO 9296 except 90% CPU. For this mode, the system CPU was stressed at 90% utilization with no other peripheral device actively seeking. This test mode is not specified in ISO 7779, but was measured using the same microphone distances and measurement techniques defined for the other reported operating modes. <sup>2</sup> Declared Sound Power rounded to nearest tenth of a bel per ISO 9296 section 4.4.2

## ACOUSTIC NOISE EMISSION INFORMATION

#### **OPTIPLEX 790 USFF**

Component	Typical Configuration
CPU	Intel I3,3.3GHZ,2c SNB 65W
Memory	1G DDR3 1333MHz
HDD (#, capacity)	250G 7200RPM SATA2
RMSD	8X 12.7 SATA DVDRW
Graphics Adapter	Intel® HD Graphics Family

The Declared Noise Emission in accordance with ISO 9296 for the Dell Optiplex 780 USFF is as follows: (all values L<sub>WAd</sub> expressed in bels; 1 bel=10 decibels, re 10<sup>-12</sup> Watts)

Operating Mode	Typical Configuration Declared Sound Power (L <sub>WAd</sub> )
Idle	3.7
HDD Operating	3.7
90% CPU	4.3
ODD Operating	4.7

The Declared A-weighted Sound Pressure Level in decibels (re  $2x10^{-5}$  Pa), at Operator, Bystander, and Desk Side Positions are measured in accordance with ISO 7779 7.6.1, 7.6.2, and C.15.2 and declared in accordance with ISO 9296 for this product is as follows<sup>1</sup>:

Operating Mode	Typical Configuration Declared Sound Pressure (LpA)			
	Tabl	е-Тор	Floor-S	Standing
	Operator Position (LpA)  Operator Position (LpA)		Operator Position (LpA)	Bystande r Position (LpA)
Idle	29.8	27.5	22.3	21.6
HDD Operating	30.8	29.2	21.9	21.5
90% CPU	36.3	34.9	26.4	25.0
ODD Operating	39.3	34.7	31.6	29.3

<sup>&</sup>lt;sup>1</sup> All tests are conducted according to ISO 7779 and declared according to ISO 9296 except 90% CPU. For this mode, the system CPU was stressed at 90% utilization with no other peripheral device actively seeking. This test mode is not specified in ISO 7779, but was measured using the same microphone distances and measurement techniques defined for the other reported operating modes.

2 Declared Sound Power rounded to nearest tenth of a bel per ISO 9296 section 4.4.2